COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE  
BOARD #: TIDA-00563  
REV: E1  
SUN REV: Not In VersionControl  

LAYER NAME = M5 Assembly Top  

PLOT NAME=Top Assembly Drawing  
GENERATED : 10/19/2015  1:39:01 PM  
TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE | BOARD #: TIDA-00563 | REV: E1 | SUN REV: Not In VersionControl
---|---|---|---
| | LAYER NAME = M6 Assembly Bottom
| PLOT NAME =Bottom Assembly Drawing | GENERATED : 10/19/2015 1:39:02 PM | TEXAS INSTRUMENTS
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